



Product Change Notification / SYST-18PFXD719

Date:

20-Sep-2023

Product Category:

16-Bit - Microcontrollers and Digital Signal Controllers

PCN Type:

Document Change

Notification Subject:

ERRATA - PIC24F16KL402 Family Silicon Errata and Data Sheet Clarification

Affected CPNs:

[SYST-18PFXD719_Affected_CPN_09202023.pdf](#)

[SYST-18PFXD719_Affected_CPN_09202023.csv](#)

Notification Text:

SYST-18PFXD719

Microchip has released a new Errata for the PIC24F16KL402 Family Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at [PIC24F16KL402 Family Silicon Errata and Data Sheet Clarification](#).

Notification Status: Final

Description of Change: Adds data sheet clarification 1 (Electrical Specifications).

Impacts to Data Sheet: None

Change Implementation Status: Complete

Date Document Changes Effective: 20 Sep 2023

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachments:

[PIC24F16KL402 Family Silicon Errata and Data Sheet Clarification](#)

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Affected Catalog Part Numbers (CPN)

PIC24F08KL200-E/P
PIC24F08KL200-E/ST
PIC24F04KL100-E/ST
PIC24F16KL401-E/SS
PIC24F08KL201-E/SS
PIC24F04KL101-E/SS
PIC24F16KL401-E/SO
PIC24F16KL402-E/SP
PIC24F16KL402-E/SS
PIC24F16KL402-E/SO
PIC24F16KL402-E/MQ
PIC24F16KL401-E/MQ
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PIC24F08KL201-I/SS
PIC24F04KL101-I/SS
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PIC24F08KL401-I/SO
PIC24F08KL301-I/SO
PIC24F08KL201-I/SO
PIC24F16KL401-I/P
PIC24F08KL301-I/P
PIC24F08KL201-I/P
PIC24F04KL101-I/P
PIC24F08KL302-I/SP
PIC24F08KL402-I/SP
PIC24F16KL402-I/SP
PIC24F08KL302-I/ML
PIC24F16KL402-I/ML
PIC24F08KL302-I/SS
PIC24F08KL402-I/SS
PIC24F16KL402-I/SS
PIC24F08KL302-I/SO
PIC24F08KL402-I/SO
PIC24F16KL402-I/SO
PIC24F08KL302-I/MQ
PIC24F16KL402-I/MQ
PIC24F16KL401-I/MQ
PIC24F08KL401-I/MQ
PIC24F08KL301-I/MQ
PIC24F08KL201-I/MQ

PIC24F04KL101-I/MQ
PIC24F16KL401T-I/SS
PIC24F08KL401T-I/SS
PIC24F08KL301T-I/SS
PIC24F08KL201T-I/SS
PIC24F04KL101T-I/SS
PIC24F16KL401T-I/SO
PIC24F16KL402T-I/ML
PIC24F08KL402T-I/SS
PIC24F16KL402T-I/SS
PIC24F08KL301T-I/MQ020
PIC24F16KL401T-I/MQ
PIC24F08KL201T-I/MQ
PIC24F04KL101T-I/MQ
PIC24F16KL401T-E/SS
PIC24F16KL402T-E/SS

PIC24F16KL402 Family Silicon Errata and Data Sheet Clarification

The PIC24F16KL402 family devices that you have received conform functionally to the current Device Data Sheet (DS30001037D), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#). The silicon issues are summarized in [Table 2](#).

The errata described in this document will be addressed in future revisions of the PIC24F16KL402 family silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of [Table 2](#) apply to the current silicon revision (**A2**).

Data Sheet clarifications and corrections start on [Page 4](#), following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate website (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with MPLAB ICD 2 or PICKIT™ 3:

1. Using the appropriate interface, connect the device to the MPLAB ICD 2 programmer/debugger or PICKIT 3.
2. From the main menu in MPLAB IDE, select **Configure>Select Device** and then select the target part number in the dialog box.
3. Select the MPLAB hardware tool (**Debugger>Select Tool**).
4. Perform a "Connect" operation to the device (**Debugger>Connect**). Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

Note: If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC24F16KL402 family silicon revisions are shown in [Table 1](#).

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾			Part Number	Device ID ⁽¹⁾	Revision ID for Silicon Revision ⁽²⁾		
		A0	A1	A2			A0	A1	A2
PIC24F04KL100	4B01h	0000h	0001h	0002h	PIC24F08KL302	4B00h	0000h	0001h	0002h
PIC24F04KL101	4B02h				PIC24F08KL401	4B0Eh			
PIC24F08KL200	4B05h				PIC24F08KL402	4B04h			
PIC24F08KL201	4B06h				PIC24F16KL401	4B1Eh			
PIC24F08KL301	4B0Ah				PIC24F16KL402	4B14h			

Note 1: The Device IDs (DEVID and DEVREV) are located at the last two implemented addresses of configuration memory space. They are shown in hexadecimal in the format "DEVID DEVREV".

2: Refer to the "[PIC24FXXKMXXX/KLXXX Flash Programming Specifications](#)" (www.microchip.com/DS30000625) for detailed information on Device and Revision IDs for your specific device.

PIC24F16KL402 FAMILY

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Issue Summary	Affected Revisions ⁽¹⁾		
				A0	A1	A2
UART (Transmit)	Transmit	1.	UTXBF flag may not indicate correctly.	X		
Oscillator (REFO)	REFO	2.	REFO output unavailable at higher frequencies.	X	X	X
HLVD (Band Gap Reference)	Band Gap Reference	3.	BGVST and IRVST bits may not become set at extremely low temperatures.	X	X	X

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**A2**).

1. Module: UART (Transmit)

The Transmit Buffer Full Flag, UTXBF (UxSTA[9]), may become cleared before the data start moving out of the full buffer. If the flag is used to determine when data can be written to the buffer, new data may not be accepted and data may not be transmitted.

Work around

Poll the Transmit Buffer Empty Flag, TRMT (UxSTA[8]), to determine when the transmit buffer is empty and can be written to.

Alternatively, configure the UART to set the Transmit Interrupt Flag (UxTXIF) whenever a character is shifted into the Transmit Shift Register (UTXISEL[1:0] = 00). When a transmit interrupt occurs, this indicates that at least one buffer position is open and that the buffer can be written to.

Affected Silicon Revisions

A0	A1	A2					
X							

2. Module: Oscillator (REFO)

When output frequencies above 16 MHz are selected for the Reference Clock Output (REFO), the peak output voltage on the REFO pin may be too low to be properly detected by external devices.

Work around

None.

Affected Silicon Revisions

A0	A1	A2					
X	X	X					

3. Module: HLVD (Band Gap Reference)

At the extreme low end of the operating temperature range (near -40°C), the BGVST and IRVST flag bits (HLVDCON[6,5]) may not become set when the voltage references are stable and ready for use.

Work around

For applications that run at extremely cold temperatures, do not use the BGVST and IRVST bits as the sole indicator of band gap readiness. Include a time-out of 750 µs between enabling and using a reference.

Affected Silicon Revisions

A0	A1	A2					
X	X	X					

PIC24F16KL402 FAMILY

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS30001037D):

Note: Corrections and additions are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

1. Module: Electrical Specifications

Adds specification DI52 (Input Leakage Current, OSCO/RA3) to [Table 26-10](#). The new specification is shown in **bold**.

TABLE 26-10: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions
DI50	IIL	Input Leakage Current ^(2,3) I/O Ports	—	0.050	±0.100	μA	VSS ≤ VPIN ≤ VDD Pin at high-impedance
DI51		VREF+, VREF-, AN0, AN1	—	0.300	±0.500	μA	VSS ≤ VPIN ≤ VDD Pin at high-impedance
DI52		OSCO/RA3	—	—	±2.0	μA	VSS ≤ VPIN ≤ VDD

- Note 1: Data in “Typ” column are at 3.3V, +25°C unless otherwise stated.
 Note 2: The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 Note 3: Negative current is defined as current sourced by the pin.

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (11/2011)

Initial release of this document; issued for revision A0. Includes silicon issues 1 (UART, Transmit) and 2 (Oscillator, REFO).

Rev B Document (4/2012)

Adds silicon issue 3 (HLVD, Band Gap Reference) to revision A0.

Adds data sheet clarifications 1 (Front Matter, Device Features), 2 (Pin Diagrams), 3 (Overview), 4 (I/O Ports), 5 (Master Synchronous Serial Port – MSSP) and 6 (Comparator).

Rev C Document (4/2013)

Adds silicon revision A1.

Rev D Document (3/2014)

Removes data sheet clarifications that were addressed in current Device Data Sheet (DS30001037C).

Adds data sheet clarifications 2 (Special Features) and 3 (Pin Diagrams).

Rev E Document (1/2016)

Adds silicon revision A2.

Rev F Document (12/2019)

Removes data sheet clarifications that were addressed in current Device Data Sheet (DS30001037D).

Rev G Document (9/2023)

Adds data sheet clarification 1 ([Electrical Specifications](#)).

PIC24F16KL402 FAMILY

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